

## **LCD Segment (Column) Driver CMOS**

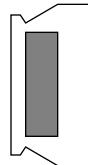
The MC141563 is a high volt, high MUX passive LCD segment driver. It is a CMOS LCD driver chip which consists of 80-channel segment driving outputs for a high MUX (up to 300 MUX) large dot matrix passive LCD panel.

This chip interfaces with 4-bit or 8-bit data bus with bidirectional shift capability. The 28 V high voltage output driving cells can be controlled by low voltage (3.0 Volts) logic input.

The MC141563 will provide the best performance in combination with the MC141562 (common driver).

- Operating Supply Voltage Range -  
Control Logic, Shift Register (VDD): 2.7V to 5.5V  
Segment Drivers (VLCD): 10 V to 28 V
- Operating Temperature Range: -20 to 70°C
- 80 LCD Segment Driving Outputs.
- Driving Duty Cycle (MUX) : 1/64 to 1/300.
- Bi-directional Shift Register Data Bus of 4-bit x 20 or 8-bit x 10 Configuration.
- Interchangeable Carry-In / Carry-Out Terminals.
- Left / Right Shift Mode Selection
- Cascadable.
- Maximum Data Clock Frequency = 8.0 MHz
- Available in SLIM TAB (Tape Automated Bonding), 103 pins

**MC141563**

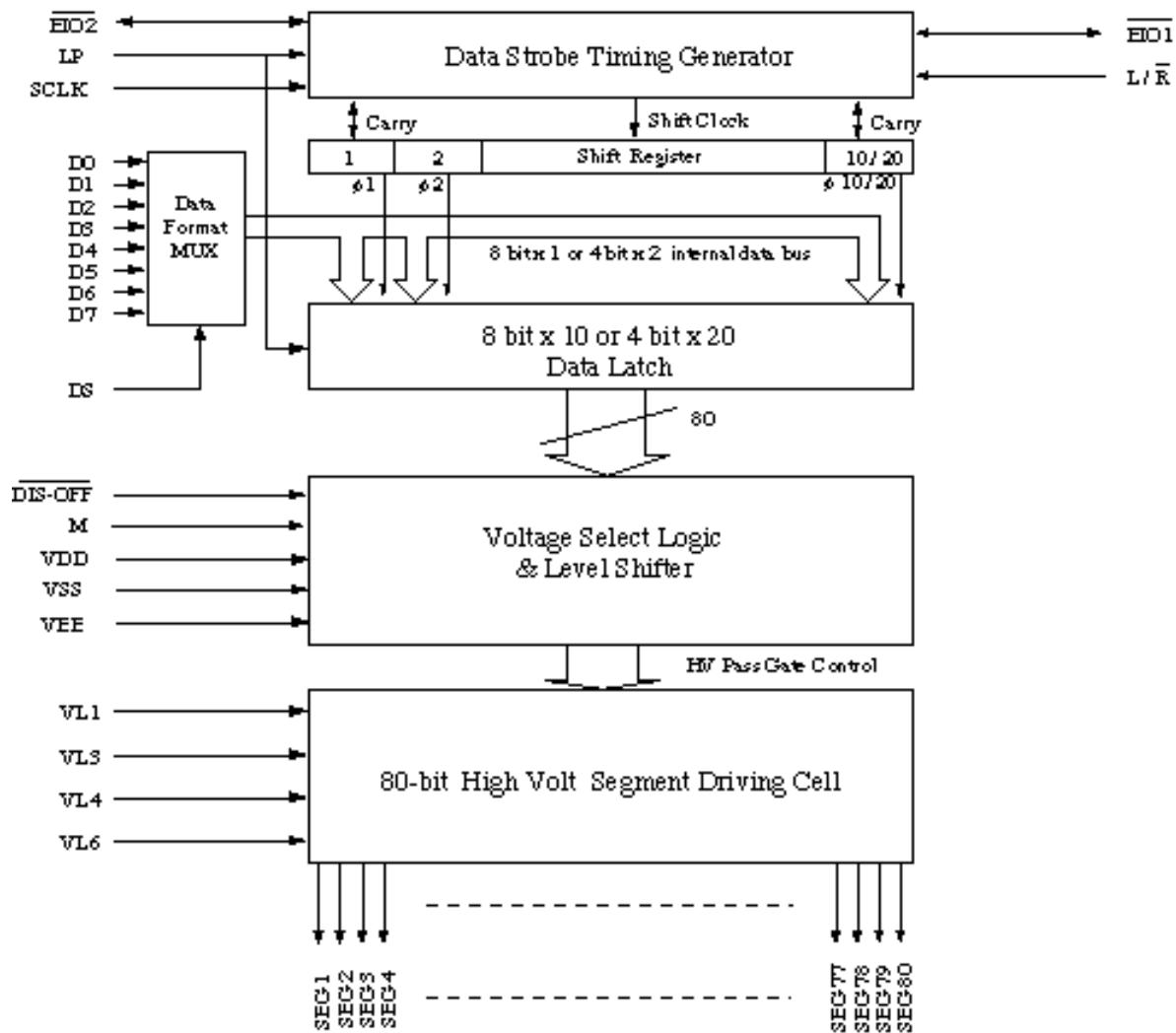


**MC141563T  
TAB**

### **ORDERING INFORMATION**

MC141563T      TAB

**Figure 1. BLOCK DIAGRAM**



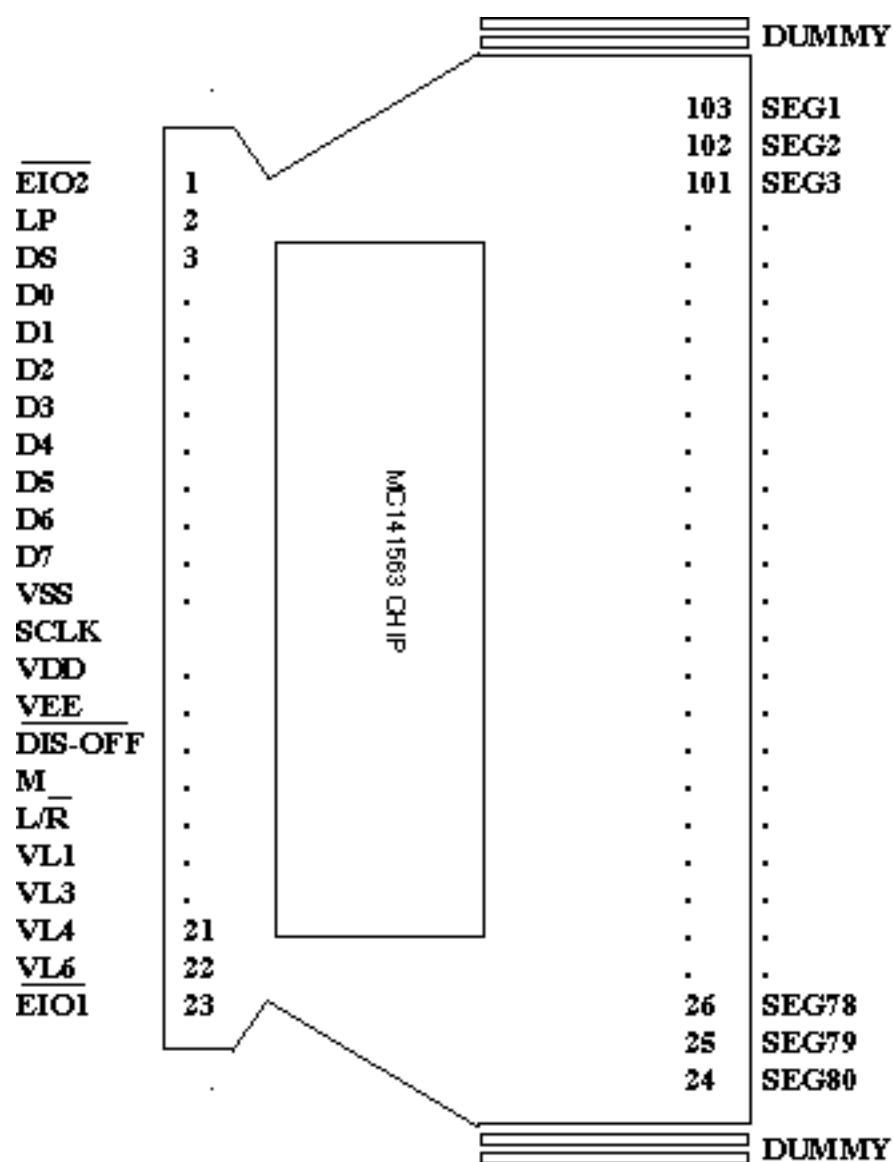


Figure 2. TAB Package Contact Assignment (Copper View)

**MAXIMUM RATINGS\***(Voltages Referenced to V<sub>SS</sub>, T<sub>A</sub>=25 C)

Symbol	Parameter	Value	Unit
V <sub>DD</sub>	Supply Voltage	-0.3 to +6.0	V
V <sub>EE</sub>		-0.3 to -24.0	V
V <sub>LCD</sub>	DC Supply Voltage (V <sub>DD</sub> - V <sub>EE</sub> )	V <sub>DD</sub> to +30	V
V <sub>Din</sub> V <sub>Ain</sub>	Input Voltage All Digital Input	V <sub>SS</sub> -0.3 to V <sub>DD</sub> +0.3	V
	V <sub>LCD</sub> Level Input	V <sub>EE</sub> -0.3 to V <sub>DD</sub> +0.3	V
I	Current Drain Per Pin Excluding V <sub>DD</sub> and V <sub>SS</sub>	25	mA
T <sub>A</sub>	Operating Temperature Range	-20 to 70	°C
T <sub>stg</sub>	Storage Temperature Range	-65 to +150	°C

\* Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the limits in the Electrical Characteristics tables or Pin Description section.

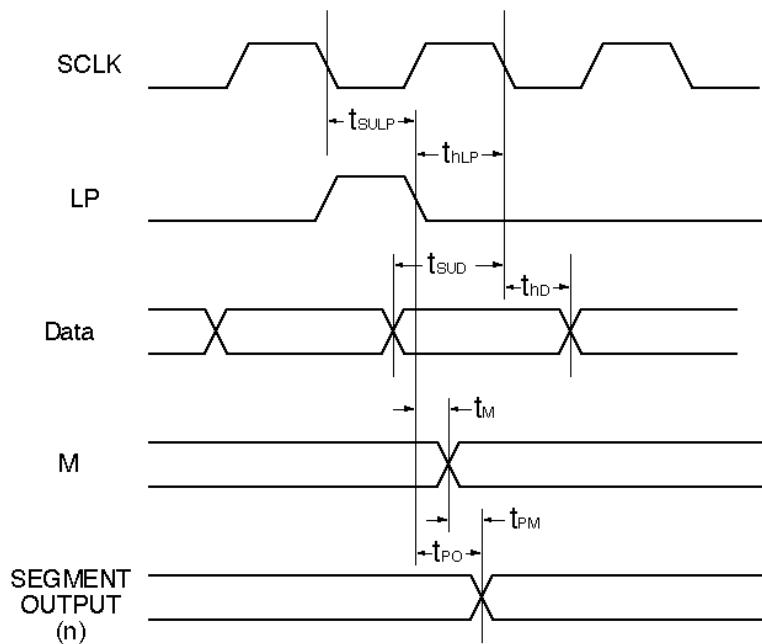
This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit. For proper operation it is recommended that V<sub>in</sub> and V<sub>out</sub> be constrained to the range V<sub>SS</sub> < or = (V<sub>in</sub> or V<sub>out</sub>) < or = V<sub>DD</sub>. Reliability of operation is enhanced if unused input are connected to an appropriate logic voltage level (e.g., either V<sub>SS</sub> or V<sub>DD</sub>). Unused outputs must be left open. This device may be light sensitive. Caution should be taken to avoid exposure of this device to any light source during normal operation. This device is not radiation protected.

**ELECTRICAL CHARACTERISTICS** (Voltage Referenced to V<sub>SS</sub>, T<sub>A</sub> = 25°C)

Symbol	Parameter	Test Condition	Min	Typ	Max	Unit
V <sub>DD</sub> V <sub>LCD</sub>	Operating Voltage Supply Voltage (reference to V <sub>SS</sub> ) LCD Supply Voltage ( V <sub>DD</sub> - V <sub>EE</sub> )		2.7 10.0	- -	5.5 28.0	V V
I <sub>DP</sub> I <sub>SB</sub>	Supply Current (V <sub>DD</sub> Pin) Display Mode Standby Mode	V <sub>DD</sub> =5.5V, V <sub>EE</sub> =-23V SCLK = 6MHz, LP=15KHz, M=35Hz	- -	250 1.5	600 5.5	µA µA
I <sub>DP</sub> I <sub>SB</sub>	Supply Current (V <sub>DD</sub> Pin) Display Mode Standby Mode	V <sub>DD</sub> =2.7V, V <sub>EE</sub> =-23V SCLK = 6MHz, LP=15KHz, M=35Hz	- -	120 600	- -	µA nA
I <sub>EE</sub>	Supply Current at V <sub>EE</sub>	No Load	-	30	550	µA
V <sub>OL</sub> V <sub>OH</sub>	Segment Output Voltage VL4,6=V <sub>EE</sub> VL1,3=V <sub>DD</sub> SEG1-SEG80	Iload = 100µA	- V <sub>DD</sub> -0.3	- -	V <sub>EE</sub> +0.3 -	V V
V <sub>OH</sub> V <sub>OL</sub>	Output High Voltage Output Low Voltage EIO1, EIO2	V <sub>DD</sub> =5.0V, Iload=1mA	V <sub>DD</sub> -1.0 -	- -	- V <sub>SS</sub> +1.0	V V
V <sub>IH</sub> V <sub>IL</sub>	Input High Voltage Input Low Voltage SCLK, LP, L/R, EIO1, EIO2, D0 to D3, M, DIS-OFF		0.7xV <sub>DD</sub> V <sub>SS</sub>	- -	V <sub>DD</sub> 0.2xV <sub>DD</sub>	V V
I <sub>in</sub>	Input Current SCLK, LP, L/R, EIO1, EIO2, D0 to D3, M, DIS-OFF		-	0.5	1.0	µA
C <sub>in</sub>	Capacitance SCLK, LP, L/R, EIO1, EIO2, D0 to D3, M, DIS-OFF		-	5	10	pF
I <sub>OHX</sub> , I <sub>OLX</sub>	Segment Output Current SEG1-SEG80	V <sub>OH</sub> = V <sub>DD</sub> - 0.3V, V <sub>OL</sub> =V <sub>EE</sub> +0.3V	100	-	-	µA
I <sub>OHC</sub> , I <sub>OLC</sub>	Carry Output Current EIO1, EIO2	V <sub>OH</sub> = V <sub>DD</sub> - 1.0V, V <sub>OL</sub> =V <sub>SS</sub> +1.0V	1.0	-	-	mA
R <sub>ON</sub>	Segment Output Impedance Segment Output Impedance Variance	V <sub>DD</sub> - V <sub>EE</sub> =28V, I <sub>OHX</sub> , I <sub>OLX</sub> = 100µA	-	1.5 10	3.0 30	K Ohm %

**AC ELECTRICAL CHARACTERISTICS -WRITE CYCLE ( $V_{DD} = 5.0V$ ,  $V_{SS} = 0V$ ,  $V_{EE} = -23V$ ,  $T_A = 25^\circ C$ )**

Symbol	Parameter	Min	Typ	Max	Unit
$t_{SUD}$	Data (D0-D3) to Shift Clock (SCLK) Set up Time	50	-	-	ns
$t_{hD}$	Data (D0-D3) to Shift Clock (SCLK) Hold Time	50	-	-	ns
$t_{SULP}$	Data Latch (LP) to Shift Clock (SCLK) Set up Time	50	-	-	ns
$t_{hLP}$	Data Latch (LP) to Shift Clock (SCLK) Hold Time	50	-	-	ns
$t_{SUS}$	Enable Input ( $\overline{EIO}$ ) to Shift Clock (SCLK) Set up Time	20	-	-	ns
$t_{SUE}$	Shift Clock (SCLK) to Enable Output ( $\overline{EIO}$ ) Set up Time	20	-	-	ns
$t_M$	Propagation Delay Time Data Latch (LP) to M	-	-	200	ns
$t_{PO}$	Data Latch (LP) to Segment Output (n)	-	-	0.5	$\mu s$
$t_{PM}$	M to Segment Output (n)	-	-	0.5	$\mu s$
$t_{PLP}$	Data Latch (LP) to $\overline{EIO}$ (Output )	-	-	50	ns
$t_{PE}$	Shift Clock (SCLK) to $\overline{EIO}$ (Output )	-	-	50	ns
$t_{CL} = 100\text{pF}$					
$t_{TLH}$	Control Input Rise and Fall Time	-	10	20	ns
$t_{THL}$	SCLK, LP, M, $\overline{EIO}_1, \overline{EIO}_2$	-	10	20	ns
$t_{SC\emptyset}$	Shift Clock (SCLK) Cycle	125	-	-	ns
	$V_{DD} = 3.0V$				
$t_{SCH}$	Shift Clock (SCLK) Pulse Width HIGH	40	-	-	ns
$t_{SCL}$	Shift Clock (SCLK) Pulse Width LOW	40	-	-	ns
$t_{LPH}$	Data Latch (LP) Pulse Width HIGH	50	-	-	ns



**Figure 3. SCLK, LP, Data, M and Segment Output Propagation Delay Timing Diagram**

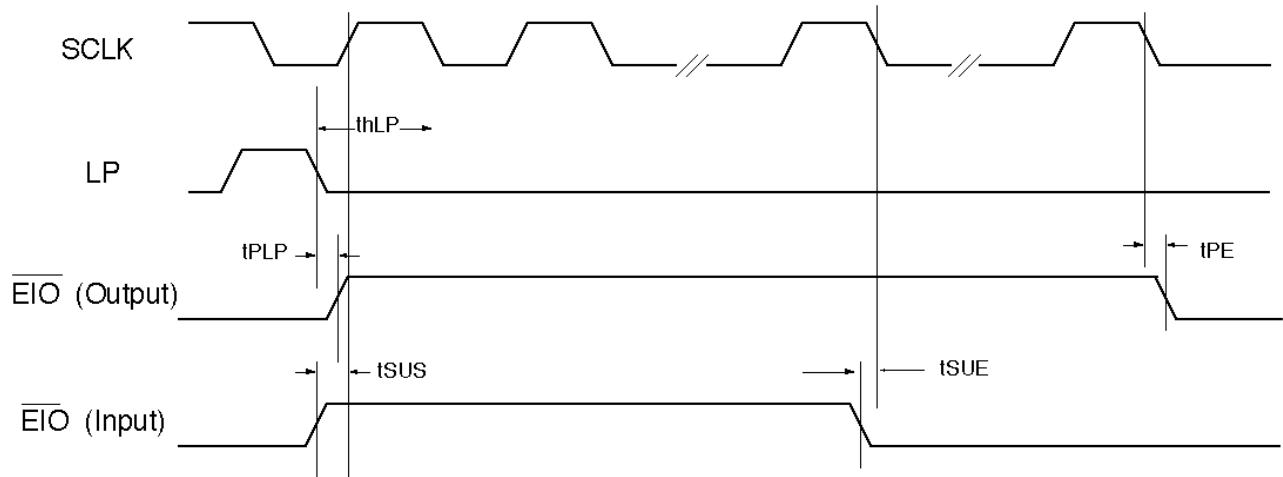


Figure 4. SCLK, LP, EIO (Input/Output) Propagation Delay Timing Diagram

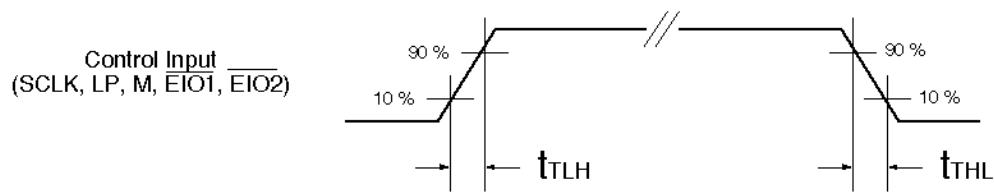


Figure 5. Control Pin Rise and Fall Timing Diagram

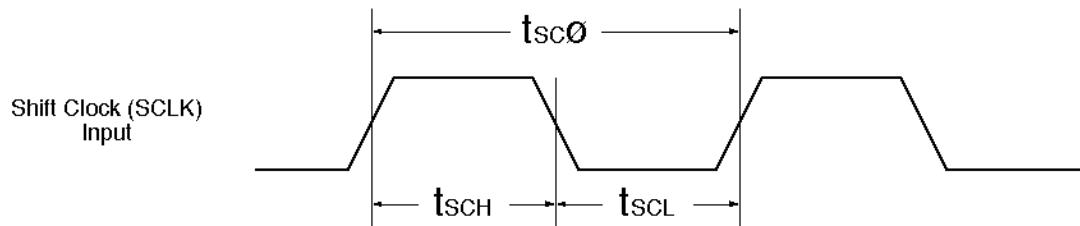


Figure 6. Shift Clock Pulse Width High and Pulse Width Low Timing Diagram

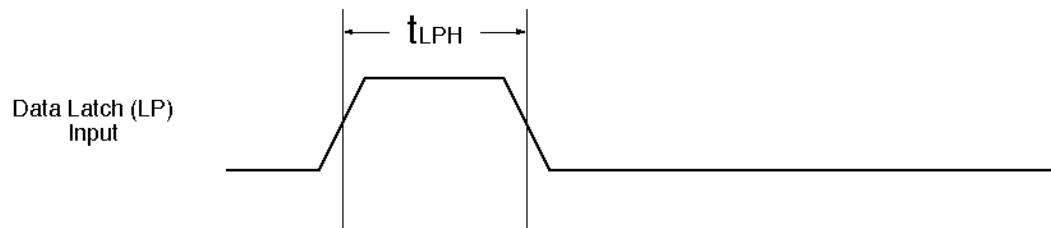


Figure 7. Data Latch Pulse Width High Timing Diagram

## PIN DESCRIPTIONS

### **V<sub>DD</sub> AND V<sub>SS</sub>**

The main dc power is supplied to the part by these two connections. V<sub>DD</sub> is the most-positive supply level and V<sub>SS</sub> is ground.

### **VEE**

This supply connection provides the negative power supply voltage for the common drivers.

### **VL1, VL3, VL4, VL6**

These input pins are connected to the external voltage divider (See Figure 8). Voltage supply level for the LCD :

VL1, VL6 : On-level of the LC

VL3, VL4 : Off-level of the LC

### **Data Latch (LP)**

Display data (a complete line on display) is acknowledged by the falling edge of the LP signal.

### **Data Shift Clock (SCLK)**

Input data (8 bit or 4 bit) is stored into a 8 bit / 4 bit data latch by the falling edge of SCLK.

### **Data Input (D0 to D7)**

Data Input is either in 8 bit or 4 bit data bus format and is selectable by the DS input.

### **Data Format Select (DS)**

This input is to select the data bus format. If set "Low", the data bus format is 4-bit, if set "High", the data bus format is 8-bit.

### **Left / Right Shift Select (L / R̄)**

This input pin provides the selection of the shift register operation (See Table 1).

- L / R̄ = "1",      the data will shift left  
(LSB of the first input data will be loaded to SEG1).
- L / R̄ = "0",      the data will shift right  
(LSB of the first input data will be loaded to SEG80).

### **Carry-In / Carry-Out (EI01 / EI02)**

These two input / output pins perform the same function and depend on the shift register direction of operation. In right shift mode (L / R̄ = "0"), the EI01 is the Carry-In input while the EI02 will be the Carry-Out output for cascading. In Left Mode (L / R̄ = "1"), the pin functions and operation are reversed. (See Table 2)

### **Frame Signal Input (M)**

This input signal is the frame sync. signal which provides an frame alternating output format of the segment output (See Figure 9).

M	0	0	1	1
Data	1	0	0	1
Output	VL1	VL3	VL4	VL6

### **Display-Off Enable (DIS-OFF)**

This input pin is active low. If set "LOW", all output pins (Segment 1 to Segment 80) are forced to VL1.

### **Segment Output (Segment 1 to Segment 80)**

These 80 output lines provide the high volt segment signal to the LCD panel. They are all at VL1 while display is turned off.

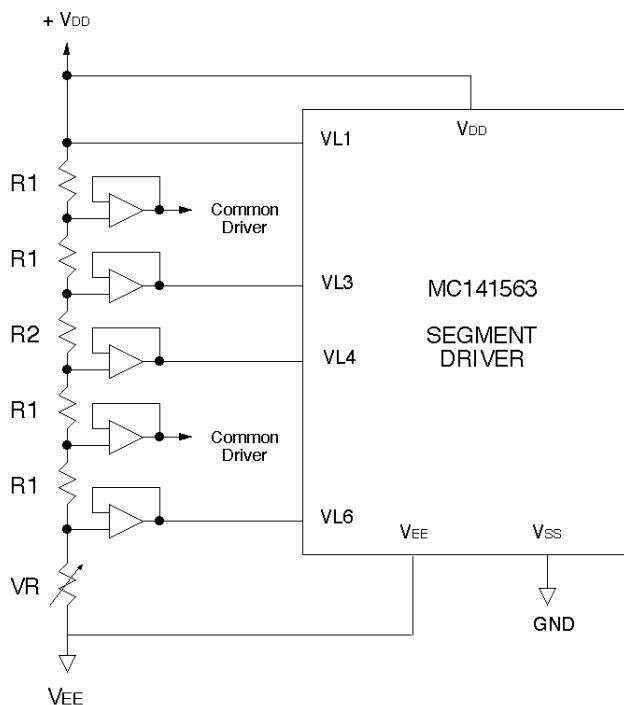


Figure 8. External Voltage Divider

L / R	SCLK :	1	2	3	4	-----	19	20
H	D0	01	06	09	13	-----	73	77
	D1	02	06	10	14	-----	74	78
	D2	03	07	11	15	-----	75	79
	D3	04	08	12	16	-----	76	80
L	D0	80	76	72	68	-----	08	04
	D1	79	75	71	67	-----	07	03
	D2	78	74	70	66	-----	06	02
	D3	77	73	69	65	-----	05	01

L / R	SCLK	1	2	-----	10
H	D0	01	09	-----	73
	D1	02	10	-----	74
	D2	03	11	-----	75
	D3	04	12	-----	76
	D4	05	13	-----	77
	D5	06	14	-----	78
	D6	07	15	-----	79
	D7	08	16	-----	80
L	D0	80	72	-----	08
	D1	79	71	-----	07
	D2	78	70	-----	06
	D3	77	69	-----	05
	D4	76	68	-----	04
	D5	75	67	-----	03
	D6	74	66	-----	02
	D7	73	65	-----	01

Table 1. Left / Right Shift Select and the Associated Data Bit Segment Output Mapping  
 (a) 4 bit interface; (b) 8 bit interface

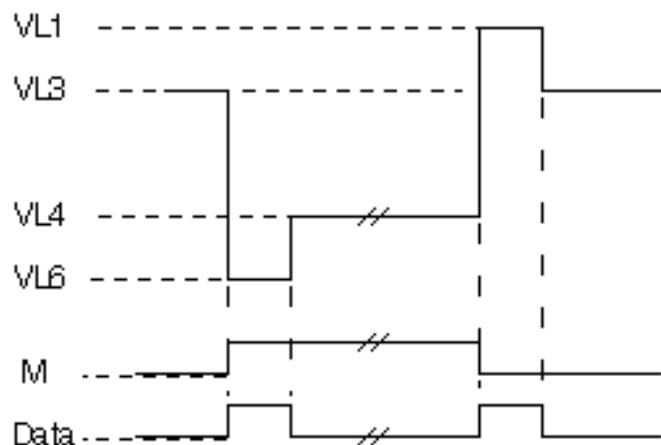


Figure 9. Data, M Inputs and Segment Output Format

L / R	EIO1	EIO2
H	OUT	IN
L	IN	OUT

Table 2. Left / Right Shift Control and EIO1, EIO2 Relation

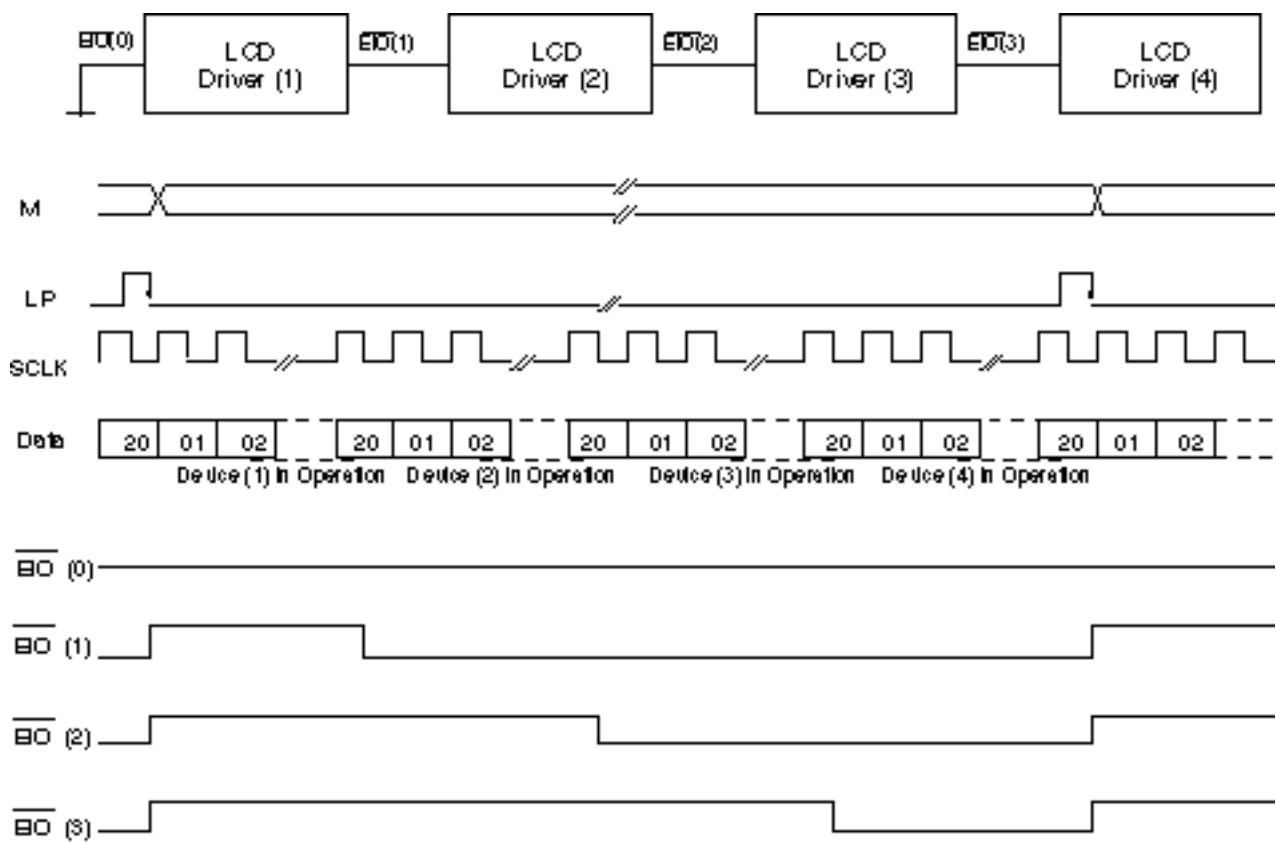


Figure 10. **EIO1** and **EIO2** in 4 Data Bit Application and Timing Diagram

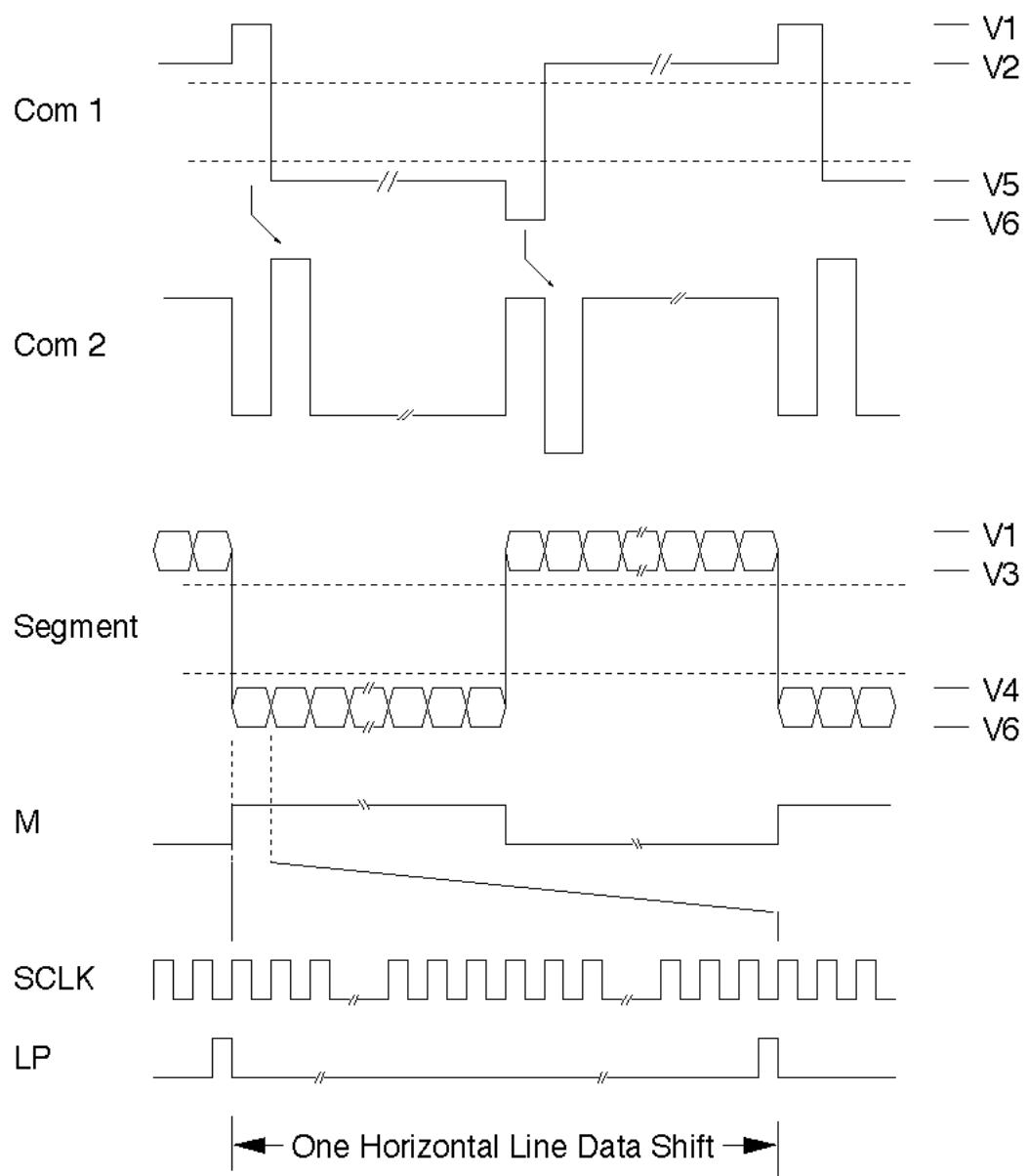
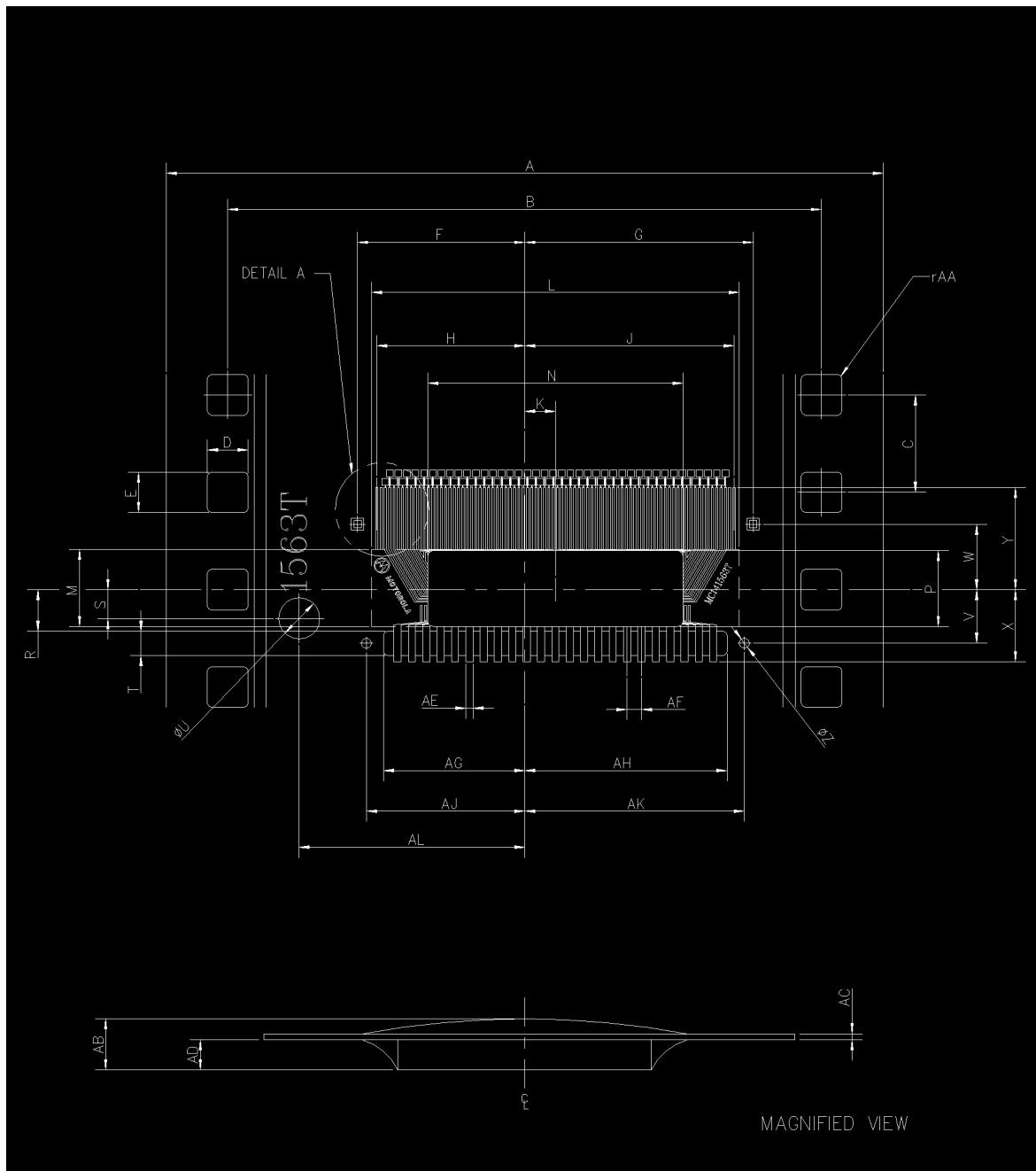


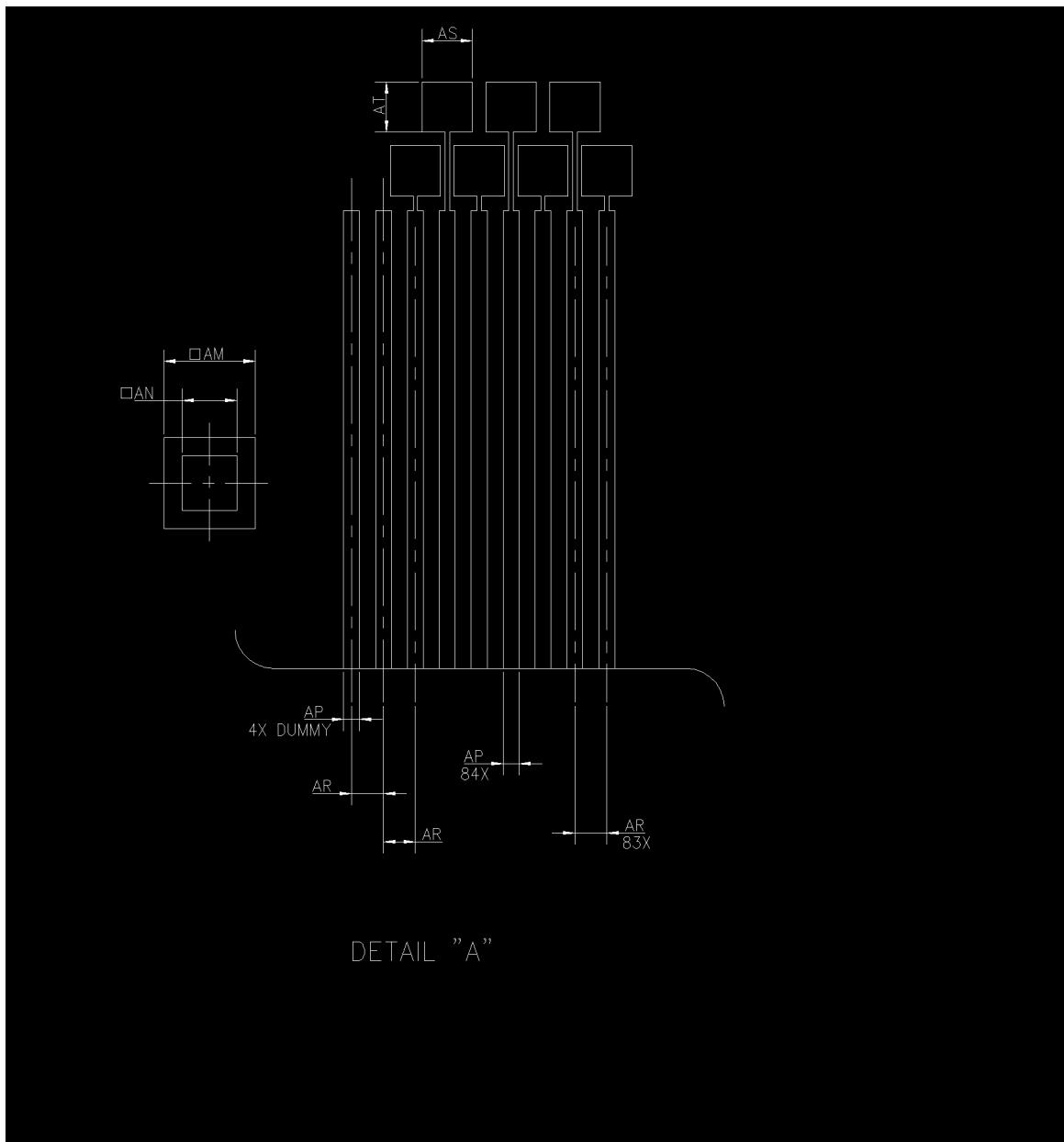
Figure 11. Common and Segment and Input Control Format Timing Diagram

## PACKAGE DIMENSIONS

**MC141563T**  
**TAB PACKAGE DIMENSION**  
**(DO NOT SCALE THIS DRAWING)**



**MC141563T**  
**TAB PACKAGE DIMENSION**  
(DO NOT SCALE THIS DRAWING)



**MC141563T TAB PACKAGE DIMENSION**

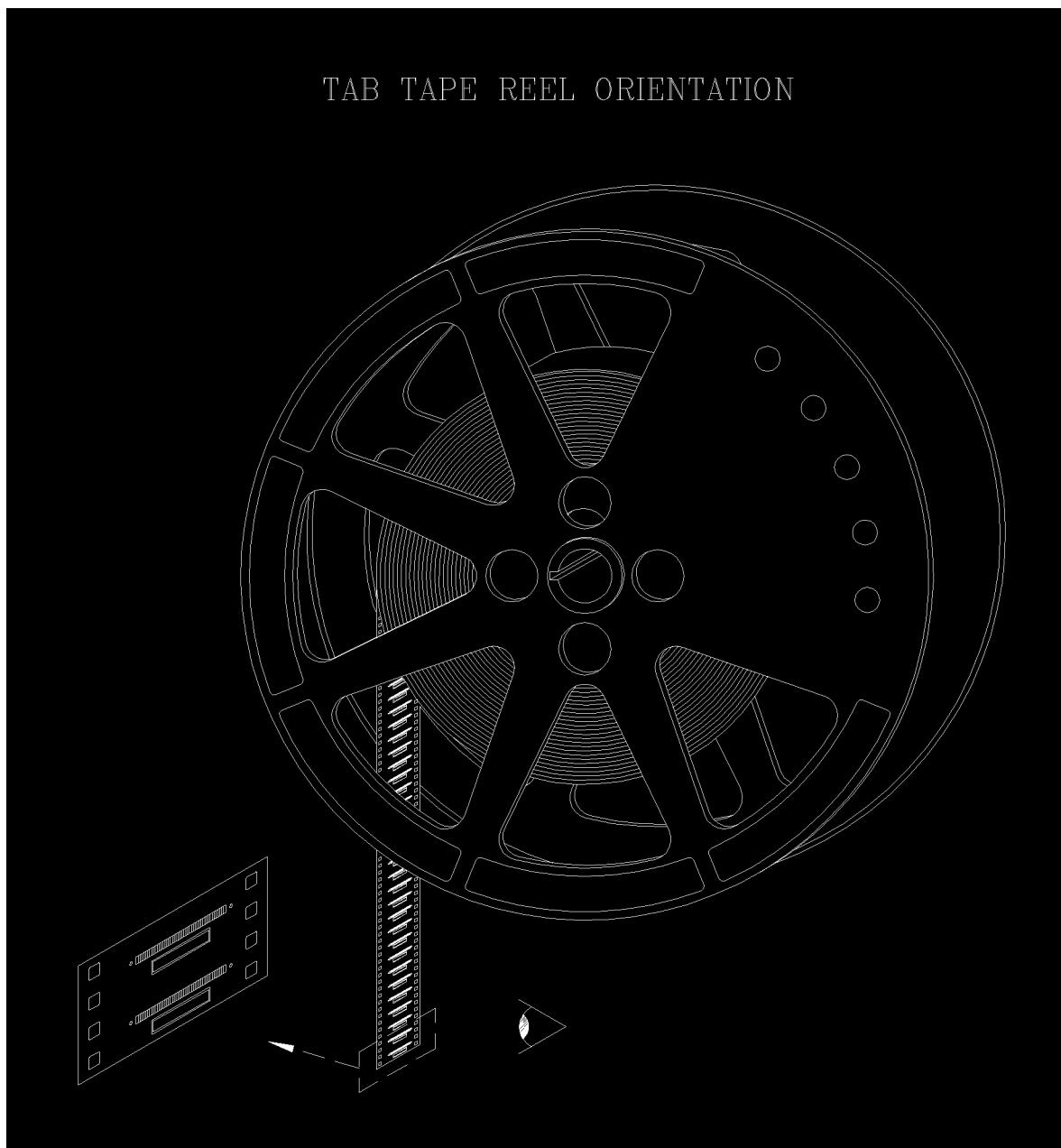
Dim	Millimeters		Inches		Dim	Millimeters		Inches	
	Min	Max	Min	Max		Min	Max	Min	Max
A	34.775	35.175	1.3691	1.3848	AC	0.068	0.083	0.0027	0.0032
B	28.927	29.027	1.1389	1.1428	AD	0.579	0.629	0.0228	0.0248
C	4.720	4.780	0.1858	0.1882	AE	0.330	0.370	0.0130	0.0146
D	1.951	2.011	0.0768	0.0792	AF	0.690	0.710	0.0272	0.0280
E	1.951	2.011	0.0768	0.0792	AG	6.825	6.925	0.2687	0.2726
F	8.100	8.200	0.3189	0.3228	AH	9.825	9.925	0.3868	0.3907
G	11.100	11.200	0.4370	0.4409	AJ	7.675	7.775	0.3022	0.3061
H	7.201	7.229	0.2835	0.2846	AK	10.675	10.775	0.4203	0.4242
J	10.195	10.235	0.4014	0.4030	AL	10.500	11.500	0.4134	0.4528
K	1.000	2.000	0.0394	0.0787	AM	0.580	0.620	0.0228	0.0244
L	17.635	18.235	0.6943	0.7179	AN	0.340	0.380	0.0134	0.0150
M	3.490	4.090	0.1374	0.1610	AP	0.085	0.125	0.0033	0.0049
N	-	12.460	-	0.4906	AR	0.200	0.220	0.0079	0.0087
P	-	3.624	-	0.1427	AS	0.280	0.380	0.0110	0.0150
R	1.962	2.062	0.0772	0.0812	AT	0.280	0.380	0.0110	0.0150
S	0.900	1.900	0.0354	0.0748					
T	1.150	1.250	0.0453	0.0492					
U	1.950	2.050	0.0768	0.0807					
V	2.562	2.662	0.1009	0.1048					
W	3.146	3.246	0.1239	0.1278					
X	3.462	3.562	0.1363	0.1402					
Y	4.938	5.038	0.1944	0.1983					
Z	0.450	0.550	0.0177	0.0217					
AA	-	0.200	-	0.0079					
AB	0.686	0.838	0.0270	0.0330					

**NOTES:**

1. Dimensioning and tolerancing per ANSI Y14.5M, 1982.
2. Controlling dimension: millimeter.
3. Copper Thickness: 1/2 oz.
4. Tin plating thickness: 0.4µm
5. 2 sprocket hole device

**MC141563T**

TAB TAPE REEL ORIENTATION



Reference : 98ASL00131A

Issue "0" released on 03/03/94

Application Example  
320 x 300

